



The AMPMODU® MTE Interconnection System offers both wire-to-board and wire-to-wire connectors using .025" (0.64mm) square post technology. FEATURES: • Insulation displacement technology • Plain housings are end-to-end and/or back-to-back stackable for open pin field applications ELECTRICAL CHARACTERISTICS: • Contact Current Rating: 3amp • Contact Termination Resistance: 15mΩ (maximum) • Dielectric Withstanding Voltage: 600VAC, rms at sea level • Operating Temperature: -65°C - 105°C MATERIAL: • Housing: Black thermoplastic, 94V-0 rated • Contacts: Phosphor bronze or Copper Alloy

A

Contact Plating: A: 30µ gold on contact area, 50µ minimum tin-lead in crimp area, with entire contact underplated 50µ nickel B: 15µ gold on contact area, 50µ minimum tin-lead in crimp area, with entire contact underplated 50µ nickel C: 100µ bright tin-lead over 50µ nickel on entire contact Unloaded: No contacts in housing

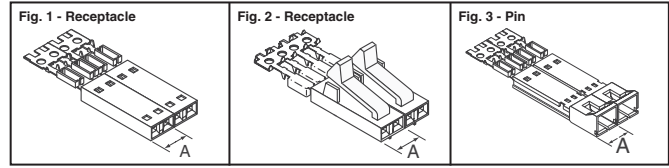


Table with columns: No. of Pos., Plating, Dimension A (mm), Digi-Key Part No., Housing Quantity per Strip, Pricing, AMP Part No. Includes sub-sections for Receptacle Assemblies, Strip Form Plain, Strip Form Polarized/Latching, and Strip Form Polarized/Latching (unloaded pin housing).

Table with columns: No. of Pos., Plating, Dimension A (mm), Digi-Key Part No., Housing Quantity per Strip, Pricing, AMP Part No. Includes sub-sections for Strip Form Polarized/Latching, RoHS Compliant, Strip Form Polarized/Latching, and Strip Form Polarized/Latching (unloaded pin housing).

Free shipping on orders over \$200 CAD! All prices in Canadian dollars and include duty and brokerage fees.